Notes:
1. Single switch version of PMP10974.
2. PMP11281Rev A schematic is built on PMP10974Rev A PCB board.

1. Single switch version of PMP10974.

Notes:

- Heat sink required

- Heat sink required

- 85VAC to 265VAC Input

2. PMP11281Rev A schematic is built on PMP10974Rev A PCB board.
Universal AC Input to 5V/48W USB charger

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Designed for:

Sheet Title: PMP10974_TID_Hardware.SchDoc
Number: 1
TID #:
Orderable:

Contacts:
File:
Sheet:
Size:

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